

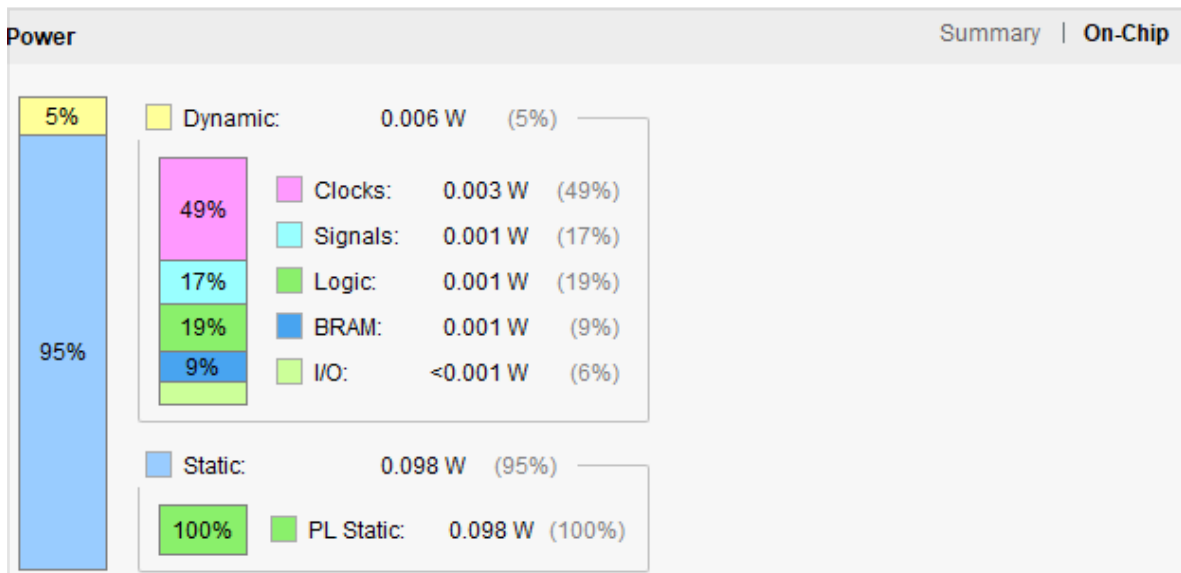
FPGA Project Test Results

1-Level Parallelization with BRAM:

- Inference Time: 1,096,045.000 ns
- Design Reports:

Resource	Utilization	Available	Utilization %
LUT	786	63400	1.24
FF	455	126800	0.36
BRAM	13	135	9.63
IO	14	210	6.67
BUFG	1	32	3.13

Power	Summary
Total On-Chip Power:	0.103 W
Junction Temperature:	25.5 °C
Thermal Margin:	59.5 °C (12.9 W)
Effective θ_{JA} :	4.6 °C/W
Power supplied to off-chip devices:	0 W
Confidence level:	Medium
Implemented Power Report	



Timing		Setup	Hold	Pulse Width
Worst Negative Slack (WNS):	2.428 ns			
Total Negative Slack (TNS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	879			
Implemented Timing Report				

Timing		Setup	Hold	Pulse Width
Worst Hold Slack (WHS):	0.169 ns			
Total Hold Slack (THS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	879			
Implemented Timing Report				

Timing		Setup	Hold	Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns			
Total Pulse Width Negative Slack (TPWS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	482			
Implemented Timing Report				

1-Level Parallelization without BRAM:

- Inference Time: 1,096,035.000 ns
- Design Reports:

Resource	Utilization	Available	Utilization %
LUT	2483	63400	3.92
FF	477	126800	0.38
IO	14	210	6.67
BUFG	1	32	3.13

Power		Summary
Total On-Chip Power:	0.106 W	
Junction Temperature:	25.5 °C	
Thermal Margin:	59.5 °C (12.9 W)	
Effective θ_{JA} :	4.6 °C/W	
Power supplied to off-chip devices:	0 W	
Confidence level:	Medium	
Implemented Power Report		

Power		Summary	On-Chip
	9%	Dynamic:	0.009 W (9%)
	28%	Clocks:	0.003 W (28%)
	29%	Signals:	0.003 W (29%)
	38%	Logic:	0.004 W (38%)
		I/O:	0.001 W (5%)
	91%	Static:	0.097 W (91%)
	100%	PL Static:	0.097 W (100%)

Timing		Setup	Hold	Pulse Width
Worst Negative Slack (WNS):	3.564 ns			
Total Negative Slack (TNS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	750			
Implemented Timing Report				

Timing		Setup	Hold	Pulse Width
Worst Hold Slack (WHS):	0.115 ns			
Total Hold Slack (THS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	750			
Implemented Timing Report				

Timing		Setup Hold Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns	
Total Pulse Width Negative Slack (TPWS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	478	
Implemented Timing Report		

4-Level Parallelization with BRAM:

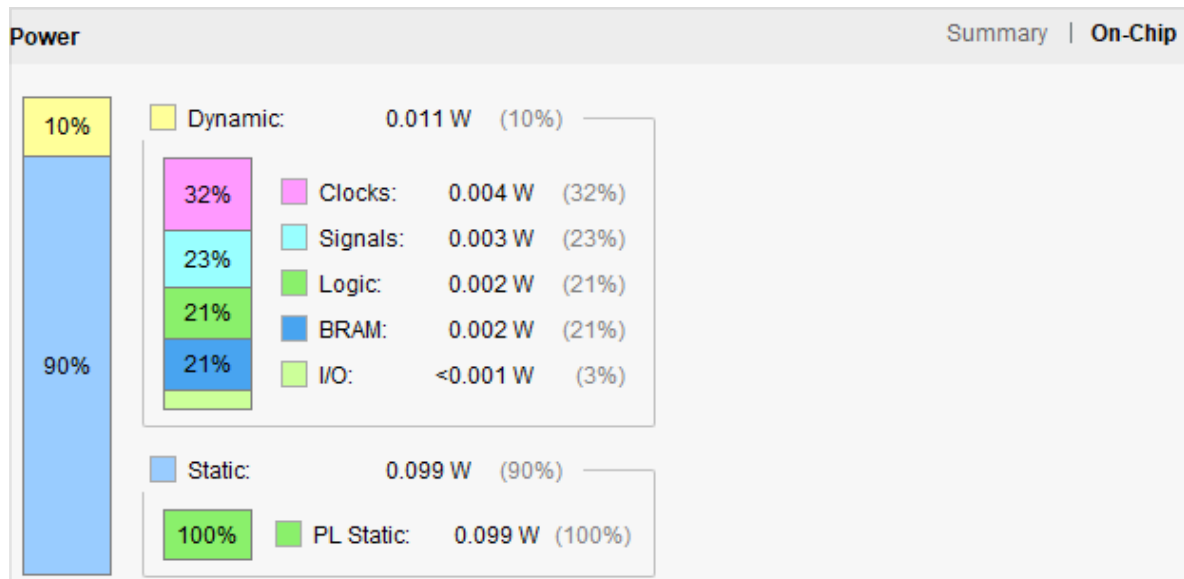
- **Inference Time:** 274,465.000 ns
- **Design Reports:**

Resource	Utilization	Available	Utilization %
LUT	1661	63400	2.62
FF	497	126800	0.39
BRAM	52	135	38.52
IO	14	210	6.67
BUFG	1	32	3.13

•

Power		Summary On-Chip
Total On-Chip Power:	0.111 W	
Junction Temperature:	25.5 °C	
Thermal Margin:	59.5 °C (12.9 W)	
Effective θ_{JA} :	4.6 °C/W	
Power supplied to off-chip devices:	0 W	
Confidence level:	Medium	
Implemented Power Report		

•



Timing		Setup	Hold	Pulse Width
Worst Negative Slack (WNS):	1.525 ns			
Total Negative Slack (TNS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	1575			
Implemented Timing Report				

Timing		Setup	Hold	Pulse Width
Worst Hold Slack (WHS):	0.132 ns			
Total Hold Slack (THS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	1575			
Implemented Timing Report				

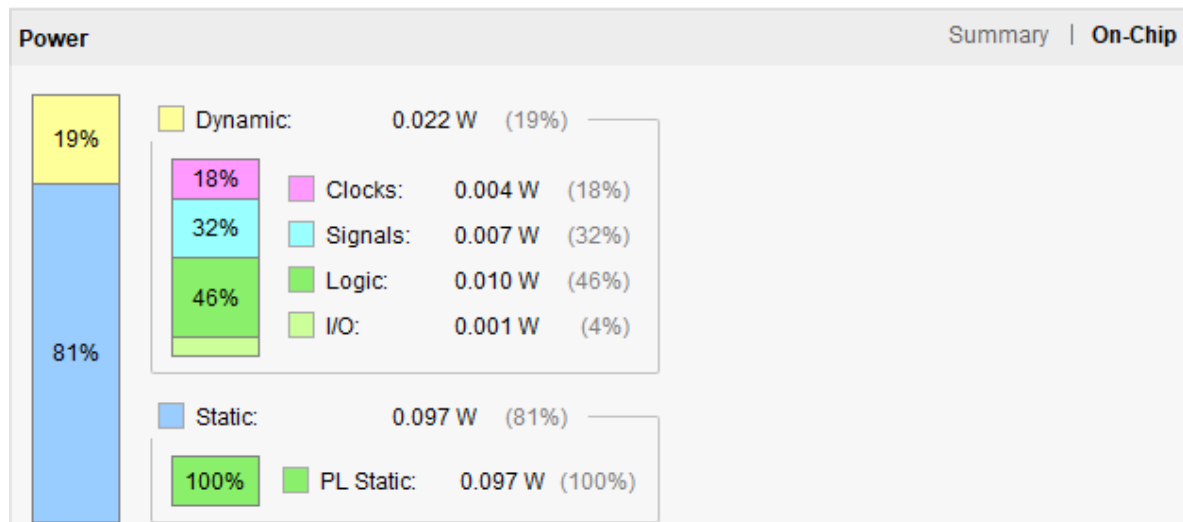
Timing		Setup	Hold	Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns			
Total Pulse Width Negative Slack (TPWS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	602			
Implemented Timing Report				

4-Level Parallelization without BRAM:

- Inference Time: 274,455.000 ns
- Design Reports:

Resource	Utilization	Available	Utilization %
LUT	6649	63400	10.49
FF	669	126800	0.53
IO	14	210	6.67
BUFG	1	32	3.13

Power		Summary On-Chip
Total On-Chip Power:	0.119 W	
Junction Temperature:	25.5 °C	
Thermal Margin:	59.5 °C (12.9 W)	
Effective θ_{JA} :	4.6 °C/W	
Power supplied to off-chip devices:	0 W	
Confidence level:	Medium	



Timing		Setup	Hold	Pulse Width
Worst Negative Slack (WNS):	1.975 ns			
Total Negative Slack (TNS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	1324			
Implemented Timing Report				

Timing		Setup	Hold	Pulse Width
Worst Hold Slack (WHS):	0.039 ns			
Total Hold Slack (THS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	1324			
Implemented Timing Report				

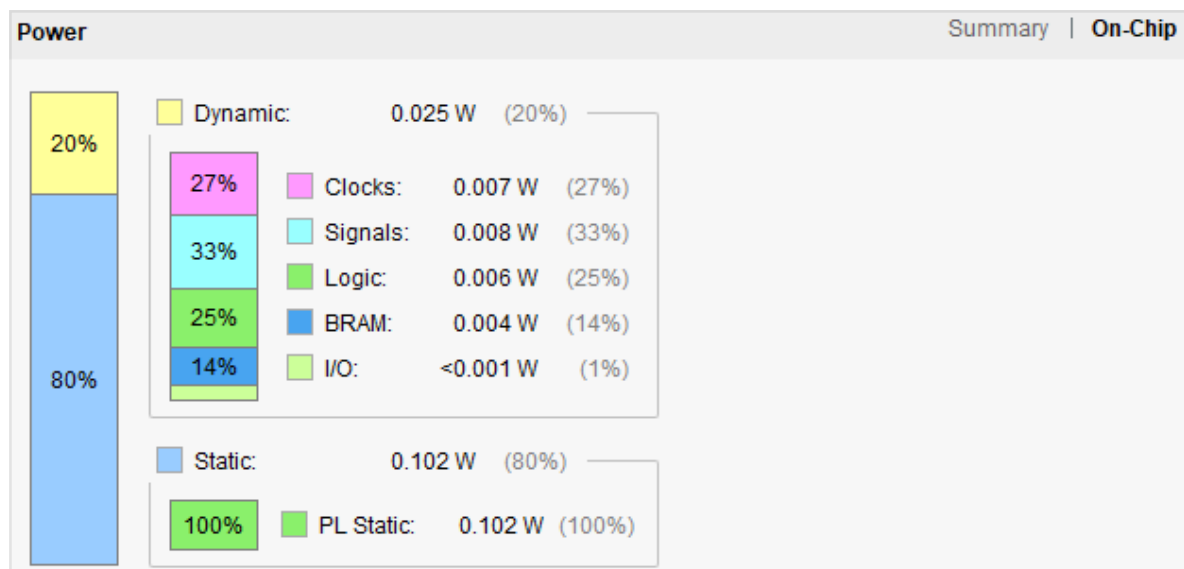
Timing		Setup	Hold	Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns			
Total Pulse Width Negative Slack (TPWS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	670			
Implemented Timing Report				

8-Level Parallelization with BRAM:

- **Inference Time:** 137,645.000 ns
- **Design Reports:**

Resource	Utilization	Available	Utilization %
LUT	3093	63400	4.88
FF	605	126800	0.48
BRAM	104	135	77.04
IO	14	210	6.67
BUFG	1	32	3.13

Power		Summary	On-Chip
Total On-Chip Power:	0.127 W		
Junction Temperature:	25.6 °C		
Thermal Margin:	59.4 °C (12.9 W)		
Effective θ_{JA} :	4.6 °C/W		
Power supplied to off-chip devices:	0 W		
Confidence level:	Medium		
Implemented Power Report			



Timing	Setup Hold Pulse Width
Worst Negative Slack (WNS):	1.043 ns
Total Negative Slack (TNS):	0 ns
Number of Failing Endpoints:	0
Total Number of Endpoints:	2200
Implemented Timing Report	

Timing	Setup Hold Pulse Width
Worst Hold Slack (WHS):	0.062 ns
Total Hold Slack (THS):	0 ns
Number of Failing Endpoints:	0
Total Number of Endpoints:	2200
Implemented Timing Report	

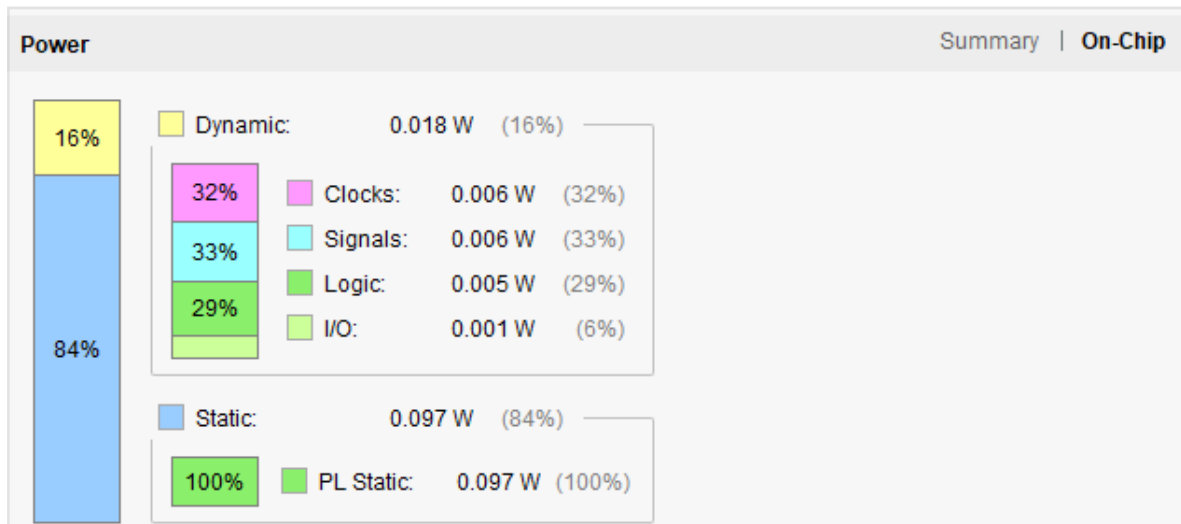
Timing	Setup Hold Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns
Total Pulse Width Negative Slack (TPWS):	0 ns
Number of Failing Endpoints:	0
Total Number of Endpoints:	814
Implemented Timing Report	

8-Level Parallelization without BRAM:

- Inference Time: 137,635.000 ns
- Design Reports:

Resource	Utilization	Available	Utilization %
LUT	12953	63400	20.43
FF	774	126800	0.61
IO	14	210	6.67
BUFG	1	32	3.13

Power		Summary On-Chip
Total On-Chip Power:	0.115 W	
Junction Temperature:	25.5 °C	
Thermal Margin:	59.5 °C (12.9 W)	
Effective θ_{JA} :	4.6 °C/W	
Power supplied to off-chip devices:	0 W	
Confidence level:	Medium	



Timing		Setup Hold Pulse Width
Worst Negative Slack (WNS):	1.708 ns	
Total Negative Slack (TNS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	1414	
Implemented Timing Report		

Timing		Setup Hold Pulse Width
Worst Hold Slack (WHS):	0.187 ns	
Total Hold Slack (THS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	1414	
Implemented Timing Report		

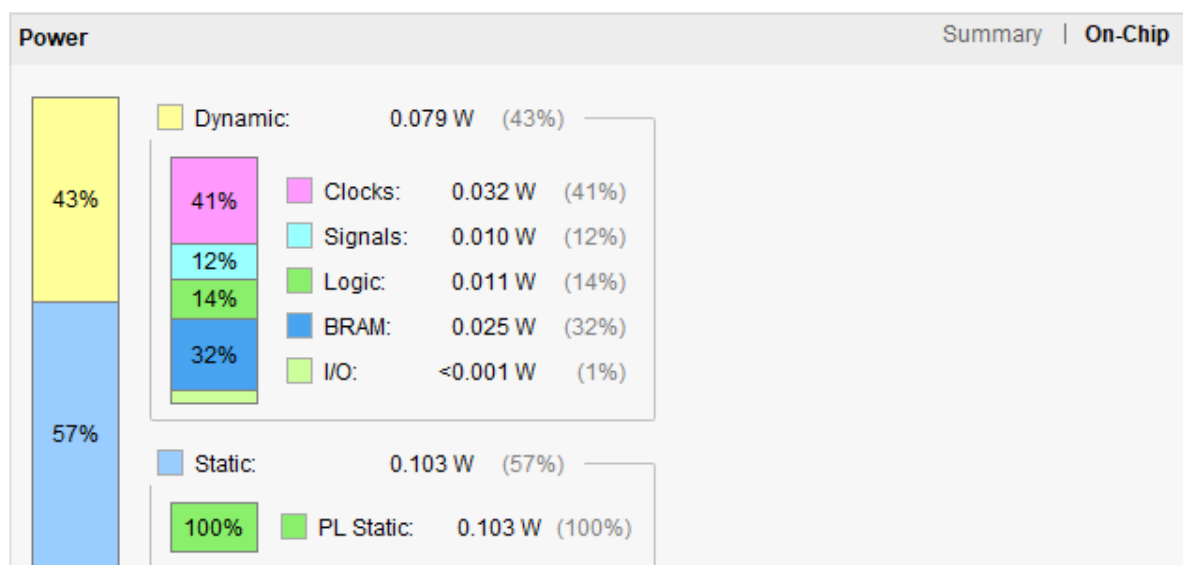
Timing		Setup Hold Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns	
Total Pulse Width Negative Slack (TPWS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	775	
Implemented Timing Report		

16-Level Parallelization with BRAM:

- Inference Time: 68,905.000 ns
- Design Reports:

Resource	Utilization	Available	Utilization %
LUT	10364	63400	16.35
FF	5716	126800	4.51
BRAM	132	135	97.78
IO	14	210	6.67
BUFG	1	32	3.13

Power		Summary On-Chip
Total On-Chip Power:	0.183 W	
Junction Temperature:	25.8 °C	
Thermal Margin:	59.2 °C (12.8 W)	
Effective θ_{JA} :	4.6 °C/W	
Power supplied to off-chip devices:	0 W	
Confidence level:	Medium	
Implemented Power Report		



Timing		Setup	Hold	Pulse Width
Worst Negative Slack (WNS):	0.37 ns			
Total Negative Slack (TNS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	7562			
Implemented Timing Report				

Timing		Setup	Hold	Pulse Width
Worst Hold Slack (WHS):	0.033 ns			
Total Hold Slack (THS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	7562			
Implemented Timing Report				

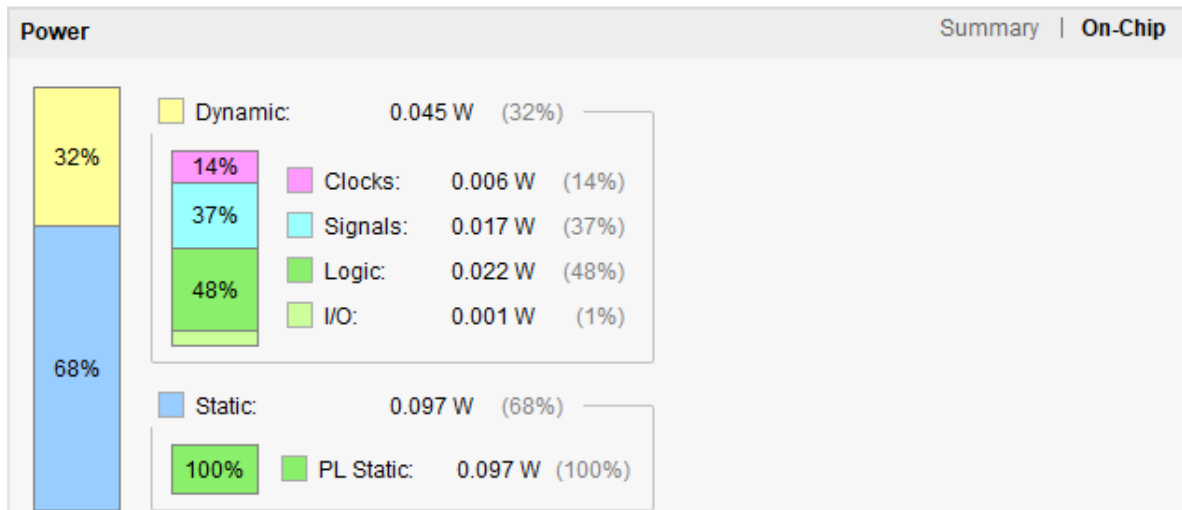
Timing		Setup	Hold	Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns			
Total Pulse Width Negative Slack (TPWS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	5981			
Implemented Timing Report				

16-Level Parallelization without BRAM:

- **Inference Time:** 68,895.000 ns
- **Design Reports:**

Resource	Utilization	Available	Utilization %
LUT	13786	63400	21.74
FF	992	126800	0.78
IO	14	210	6.67
BUFG	1	32	3.13

Power		Summary On-Chip
Total On-Chip Power:	0.142 W	
Junction Temperature:	25.6 °C	
Thermal Margin:	59.4 °C (12.9 W)	
Effective θ_{JA} :	4.6 °C/W	
Power supplied to off-chip devices:	0 W	
Confidence level:	Medium	



Timing		Setup Hold Pulse Width
Worst Negative Slack (WNS):	1.109 ns	
Total Negative Slack (TNS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	1950	

Timing		Setup Hold Pulse Width
Worst Hold Slack (WHS):	0.05 ns	
Total Hold Slack (THS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	1950	

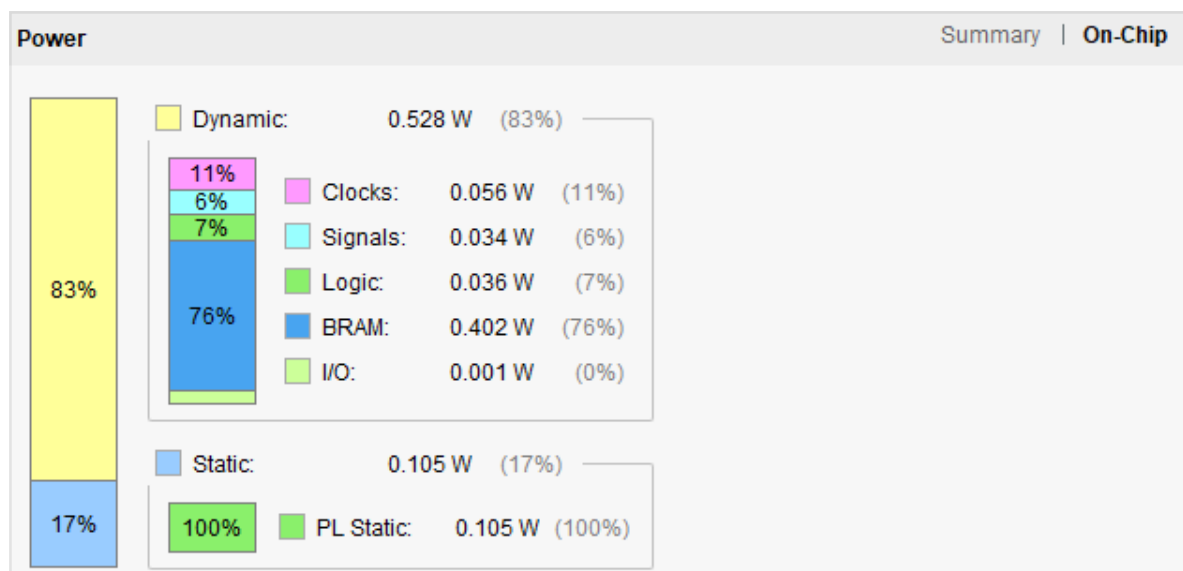
Timing		Setup Hold Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns	
Total Pulse Width Negative Slack (TPWS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	993	

32-Level Parallelization with BRAM:

- Inference Time: 34,865.000 ns
- Design Reports:

Resource	Utilization	Available	Utilization %
LUT	14401	63400	22.71
FF	15889	126800	12.53
BRAM	132	135	97.78
IO	14	210	6.67
BUFG	1	32	3.13

Power		Summary On-Chip
Total On-Chip Power:	0.633 W	
Junction Temperature:	27.9 °C	
Thermal Margin:	57.1 °C (12.4 W)	
Effective θJA:	4.6 °C/W	
Power supplied to off-chip devices:	0 W	
Confidence level:	Medium	
Implemented Power Report		



Timing	Setup Hold Pulse Width
Worst Negative Slack (WNS):	0.68 ns
Total Negative Slack (TNS):	0 ns
Number of Failing Endpoints:	0
Total Number of Endpoints:	17511
Implemented Timing Report	

Timing	Setup Hold Pulse Width
Worst Hold Slack (WHS):	0.075 ns
Total Hold Slack (THS):	0 ns
Number of Failing Endpoints:	0
Total Number of Endpoints:	17511
Implemented Timing Report	

Timing	Setup Hold Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns
Total Pulse Width Negative Slack (TPWS):	0 ns
Number of Failing Endpoints:	0
Total Number of Endpoints:	16154
Implemented Timing Report	

32-Level Parallelization without BRAM:

- Inference Time: 34,855.000 ns
- Design Reports:

Resource	Utilization	Available	Utilization %
LUT	11541	63400	18.20
FF	1217	126800	0.96
IO	14	210	6.67
BUFG	1	32	3.13

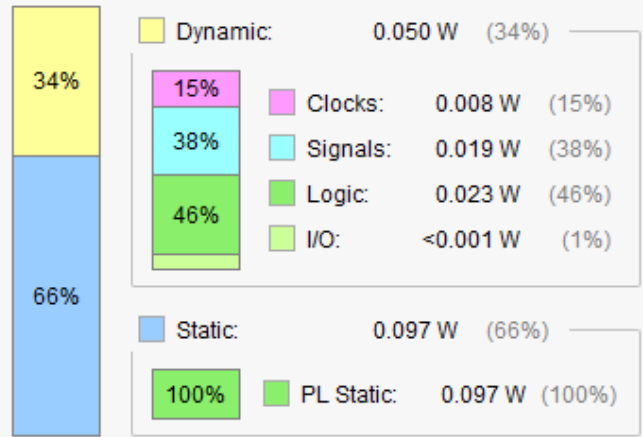
Power

[Summary](#) | [On-Chip](#)

Total On-Chip Power: 0.147 W
Junction Temperature: 25.7 °C
 Thermal Margin: 59.3 °C (12.9 W)
 Effective θ_{JA} : 4.6 °C/W
 Power supplied to off-chip devices: 0 W
 Confidence level: [Medium](#)

Power

[Summary](#) | [On-Chip](#)



Timing

[Setup](#) | [Hold](#) | [Pulse Width](#)

Worst Negative Slack (WNS): 1.95 ns
Total Negative Slack (TNS): 0 ns
Number of Failing Endpoints: 0
Total Number of Endpoints: 2266

[Implemented Timing Report](#)

Timing		Setup	Hold	Pulse Width
Worst Hold Slack (WHS):	0.129 ns			
Total Hold Slack (THS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	2266			
Implemented Timing Report				

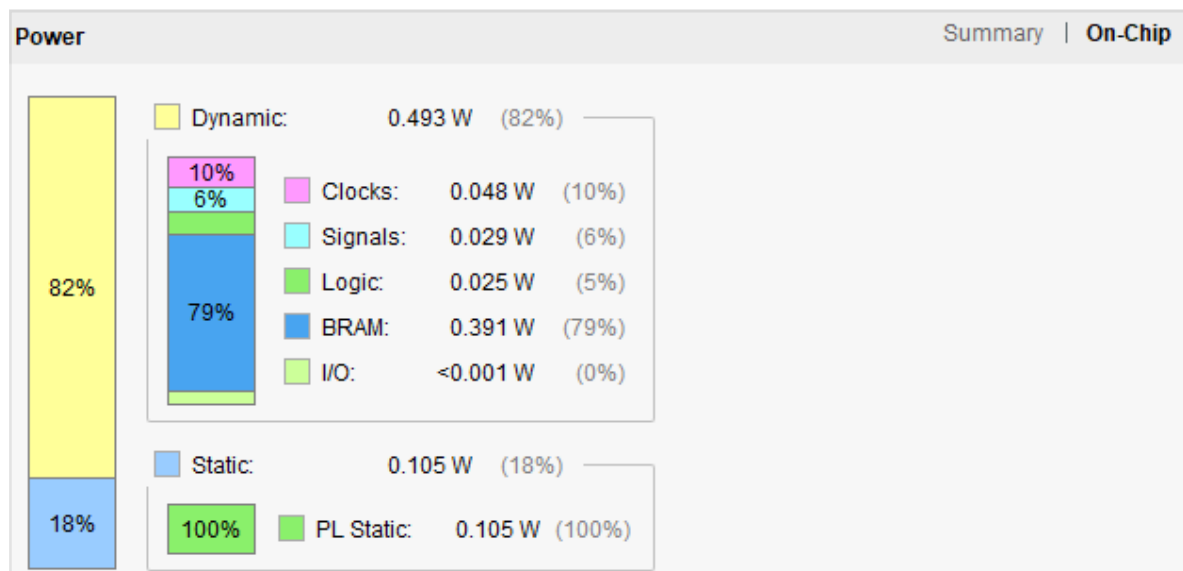
Timing		Setup	Hold	Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns			
Total Pulse Width Negative Slack (TPWS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	1218			
Implemented Timing Report				

64-Level Parallelization with BRAM:

- **Inference Time:** 17,845.000 ns
- **Design Reports:**

Resource	Utilization	Available	Utilization %
LUT	16494	63400	26.02
FF	10670	126800	8.41
BRAM	132	135	97.78
IO	14	210	6.67
BUFG	1	32	3.13

Power		Summary	On-Chip
Total On-Chip Power:	0.598 W		
Junction Temperature:	27.7 °C		
Thermal Margin:	57.3 °C (12.4 W)		
Effective θ_{JA} :	4.6 °C/W		
Power supplied to off-chip devices:	0 W		
Confidence level:	Medium		
Implemented Power Report			



Timing		Setup	Hold	Pulse Width
Worst Negative Slack (WNS):	0.939 ns			
Total Negative Slack (TNS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	12738			
Implemented Timing Report				

Timing		Setup	Hold	Pulse Width
Worst Hold Slack (WHS):	0.081 ns			
Total Hold Slack (THS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	12738			
Implemented Timing Report				

Timing		Setup	Hold	Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns			
Total Pulse Width Negative Slack (TPWS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	10935			
Implemented Timing Report				

64-Level Parallelization without BRAM:

- Inference Time: 17,835.000 ns
- Design Reports:

Resource	Utilization	Available	Utilization %
LUT	15272	63400	24.09
FF	1850	126800	1.46
IO	14	210	6.67
BUFG	1	32	3.13

Power		Summary On-Chip
Total On-Chip Power:	0.156 W	
Junction Temperature:	25.7 °C	
Thermal Margin:	59.3 °C (12.9 W)	
Effective θ_{JA} :	4.6 °C/W	
Power supplied to off-chip devices:	0 W	
Confidence level:	Medium	

Timing		Setup Hold Pulse Width
Worst Negative Slack (WNS):	0.519 ns	
Total Negative Slack (TNS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	3612	
Implemented Timing Report		

Timing		Setup Hold Pulse Width
Worst Hold Slack (WHS):	0.04 ns	
Total Hold Slack (THS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	3612	
Implemented Timing Report		

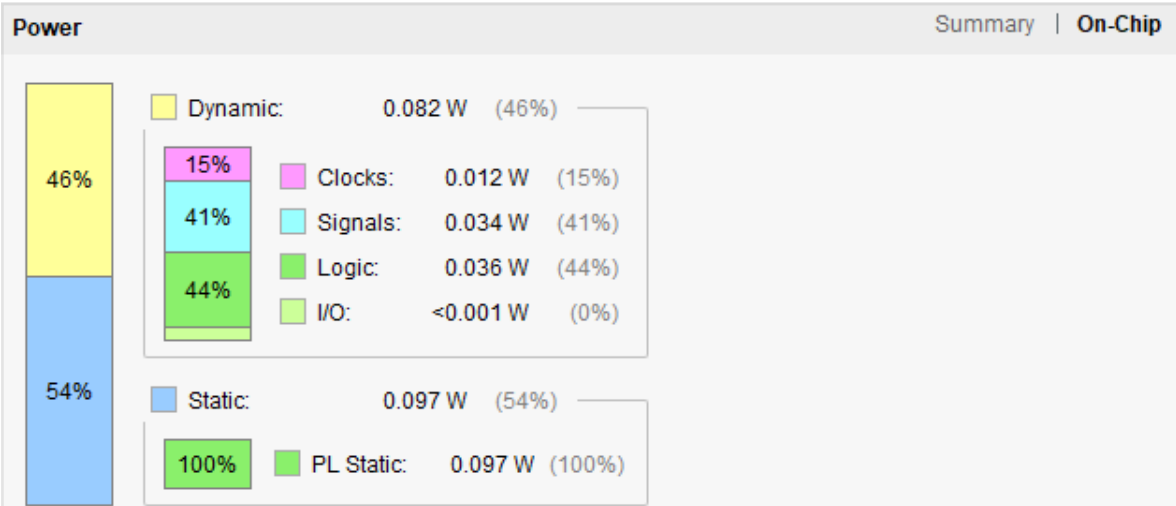
Timing		Setup Hold Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns	
Total Pulse Width Negative Slack (TPWS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	1851	
Implemented Timing Report		

128-Level Parallelization without BRAM:

- Inference Time: 9,865.000 ns
- Design Reports:

Resource	Utilization	Available	Utilization %
LUT	18626	63400	29.38
FF	3144	126800	2.48
IO	14	210	6.67
BUFG	1	32	3.13

Power		Summary On-Chip
Total On-Chip Power:	0.179 W	
Junction Temperature:	25.8 °C	
Thermal Margin:	59.2 °C (12.8 W)	
Effective θ_{JA} :	4.6 °C/W	
Power supplied to off-chip devices:	0 W	
Confidence level:	Medium	
Implemented Power Report		



Timing		Setup Hold Pulse Width
Worst Negative Slack (WNS):	1.163 ns	
Total Negative Slack (TNS):	0 ns	
Number of Failing Endpoints:	0	
Total Number of Endpoints:	6232	
Implemented Timing Report		

Timing		Setup	Hold	Pulse Width
Worst Hold Slack (WHS):	0.025 ns			
Total Hold Slack (THS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	6232			
Implemented Timing Report				

Timing		Setup	Hold	Pulse Width
Worst Pulse Width Slack (WPWS):	5.75 ns			
Total Pulse Width Negative Slack (TPWS):	0 ns			
Number of Failing Endpoints:	0			
Total Number of Endpoints:	3145			
Implemented Timing Report				